

Mutualized Security Characterization Platform for Teaching, Research and Development

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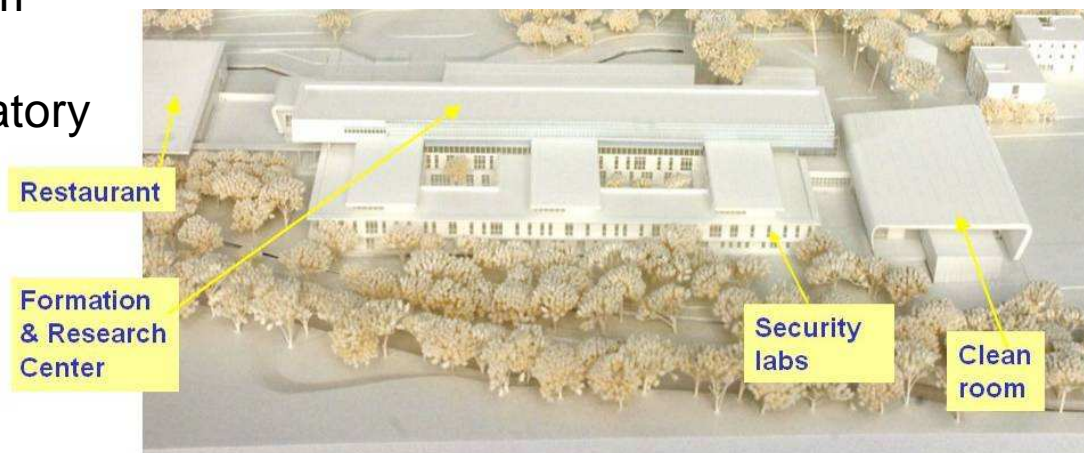
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Context

- In 2005, creation of an unique common research tool in France :
« CIM PACA »
 - Three interconnected R&D platforms :
 - “Design platform”
 - “Characterization platform”
 - “MicroPackS platform”
 - Public/private partnership structure
- The MicroPackS platform works on flexible micropackaging and security characterization at ENSMSE-SGC in Gardanne.

This platform is composed of :

- 600m² of clean room
- 90 m² of security characterization laboratory



Members

Founder members :



Associated members :

Industrial:
ATMEL, ASK, Impika, Inside,
Academic:
L2MP/TECSEN (U1-U3),
GCOM2/LP3 (U2)

? **Your institution!** ?

Public fundings :



Aims

The industrials are able to quickly characterize the security of their products and, if necessary, improve them before the certification process.

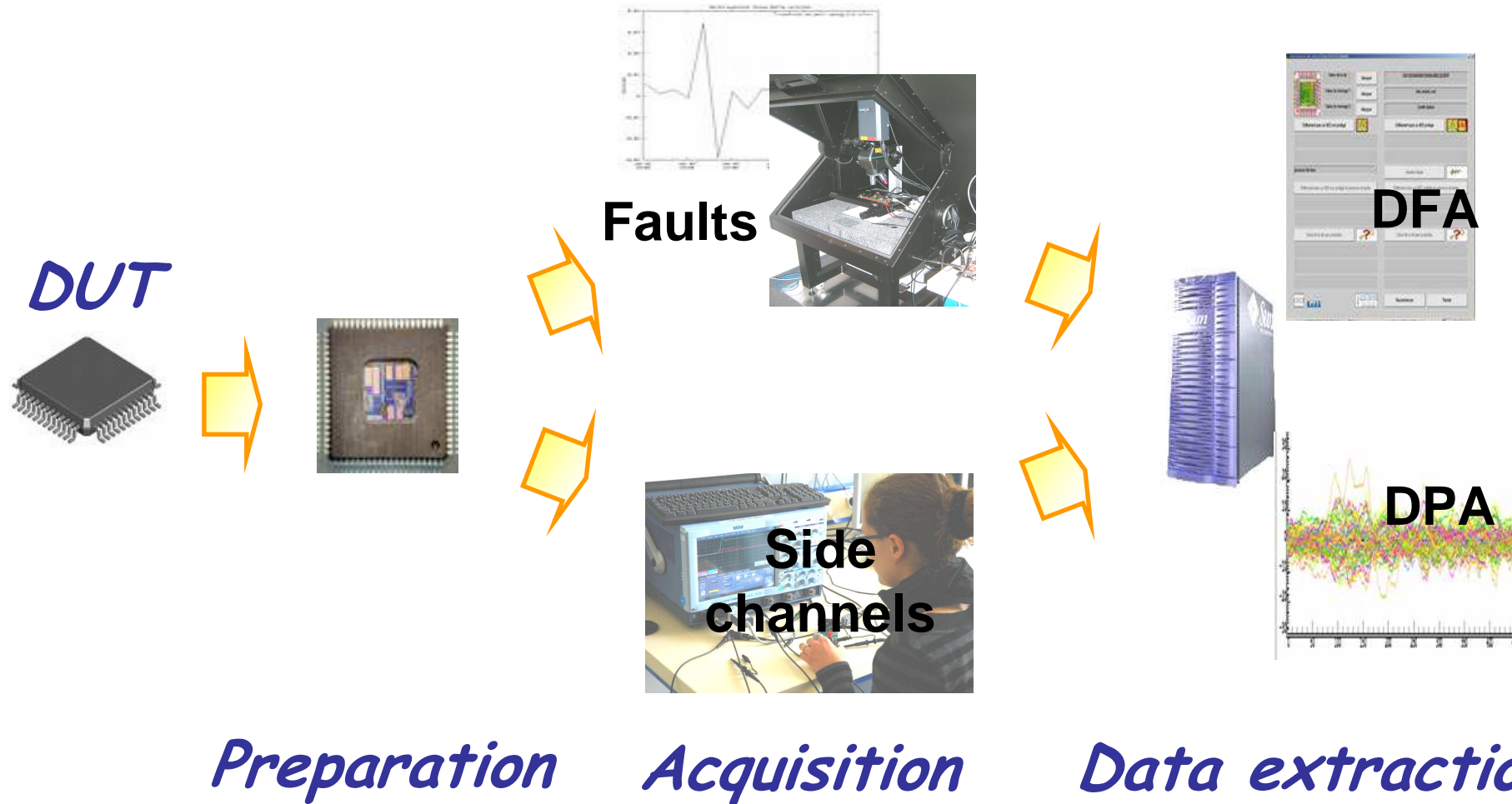
Small and medium enterprises have access to high end equipment at the lowest cost.

Academics are able to improve their knowledge on security and evaluate the efficiency of their counter-measures.

The lab is already used for training in security courses.

- Platform **is** :
 - A structure which gives access to R&D equipments
 - A place to develop innovative technology blocks
 - An organization to setup cooperative projects
- Platform **isn't** :
 - An academic lab
 - A service provider
 - An official evaluation lab (CESTI, ITSEF).

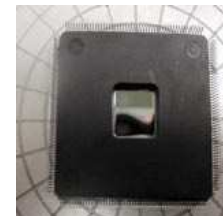
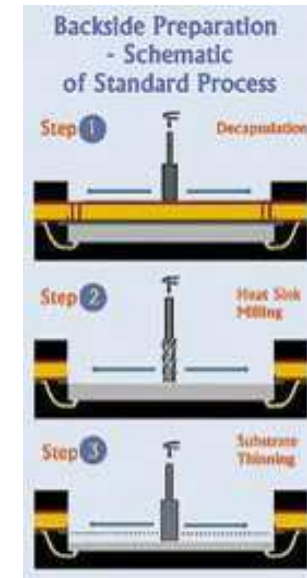
Opportunities



Preparation of components

- Thinning of packaged IC
 - Back side
 - Front side

- Anti-reflective coating
 - Quality of picture during imaging
 - Impact of laser during attacks



Before

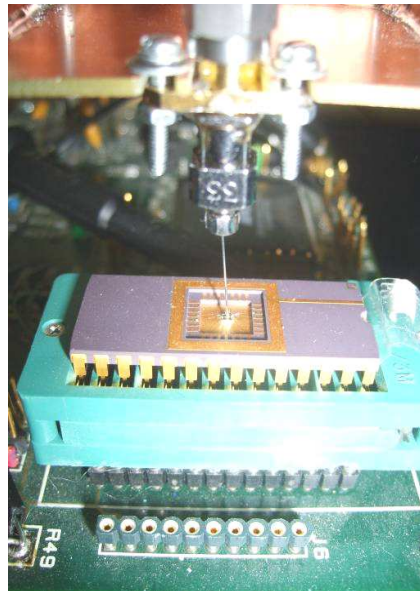
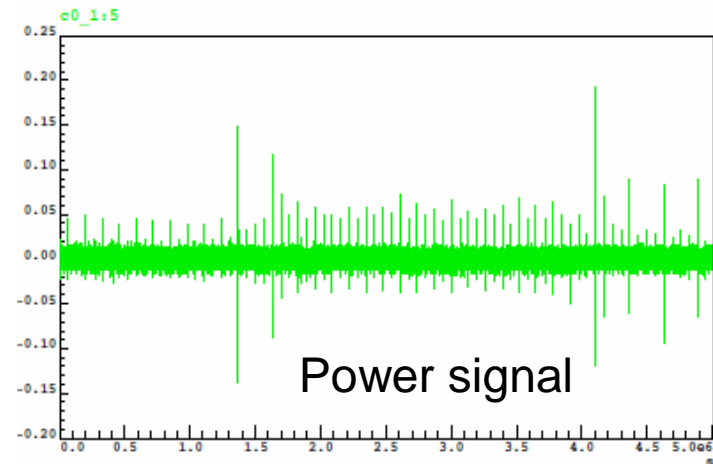
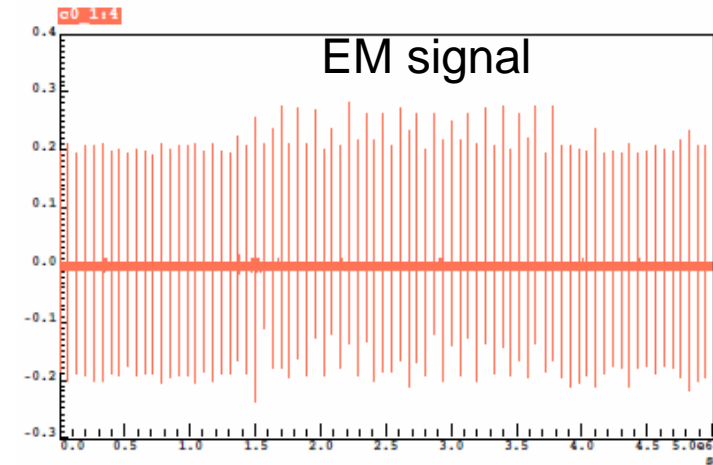


After



Side channels

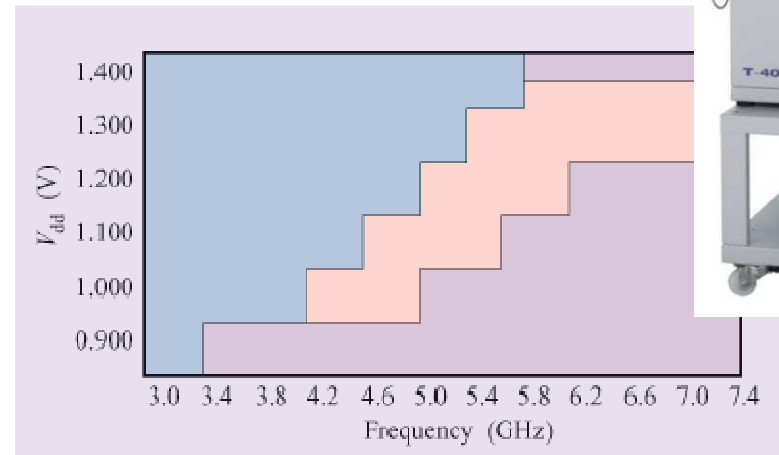
- Differential probes
- E and H probes
- High bandwidth oscilloscopes
- XY stage
- Camera
- ISO reader (optional)



Electrical tests

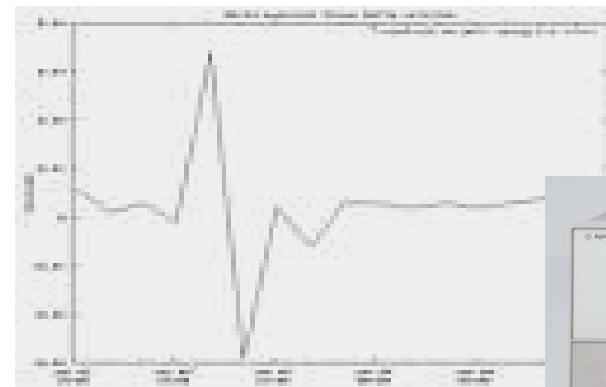
Parametrical test

- Voltage
- Temperature
- Clock



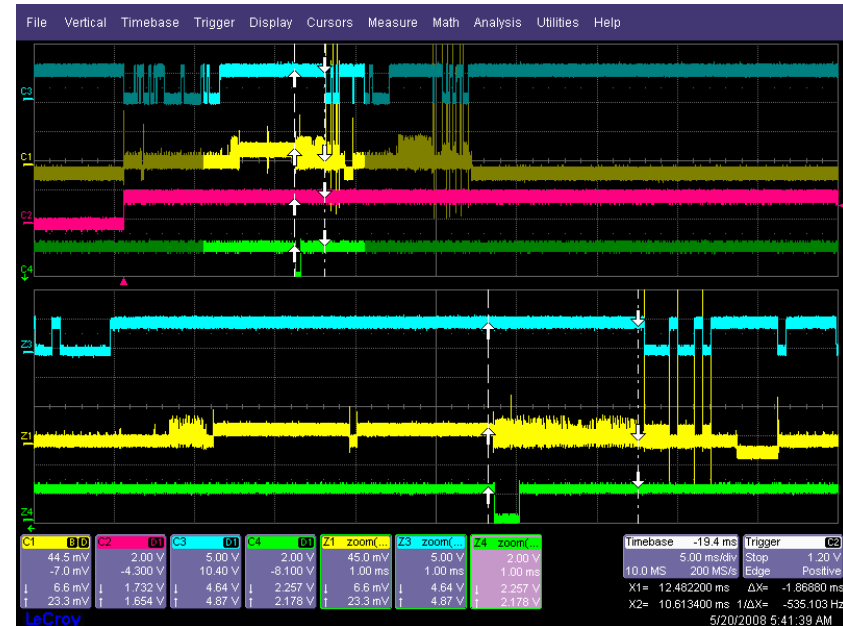
Glitches

- Voltage
- Clock



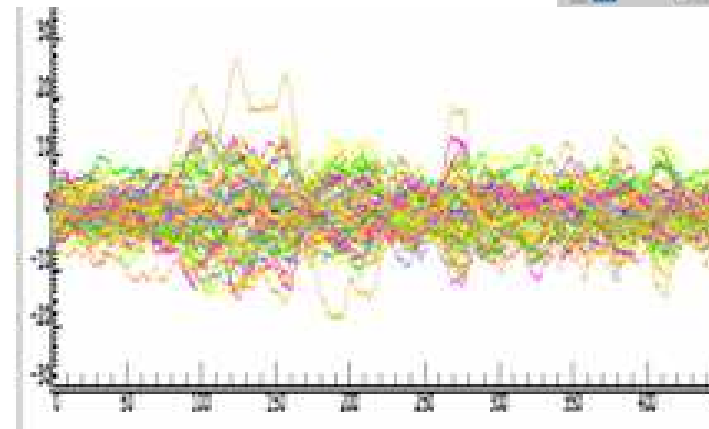
Laser

- Laser (IR, Green, UV)
- XY stage
- Camera
- Oscilloscope
- Synchronization board
- ISO Reader (optional)



Servers and software tools

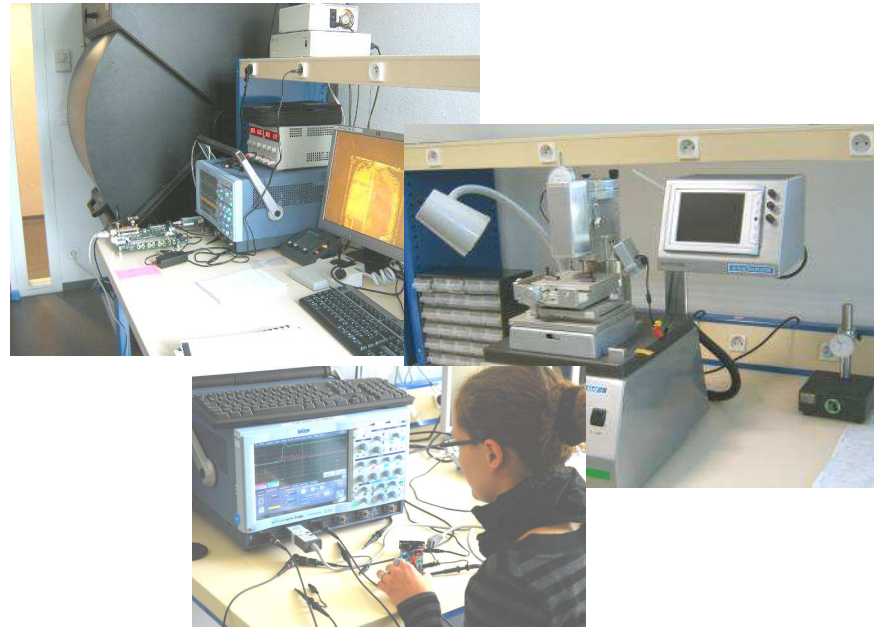
- Computational resources
 - Sun server (8 processors, 16 GB RAM)
 - 1 TB HDD
 - Backup / recovery system
 - Available from each box
- Data extraction softwares
 - DPA
 - DFA
 - DBA



Around

Research projects

- BTRS
- Calisson
- SOS
- Sacose
- ...



Development

- Gemalto
- STM
- SPS
- PSI
- ...

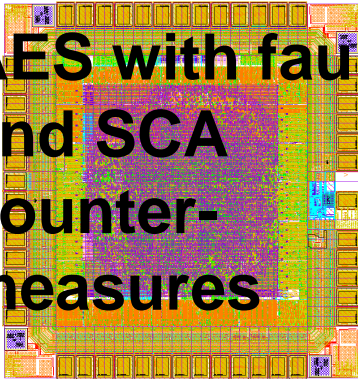
Education

- SISA master
- ...

Research: tasks performed on the platform

BTRS

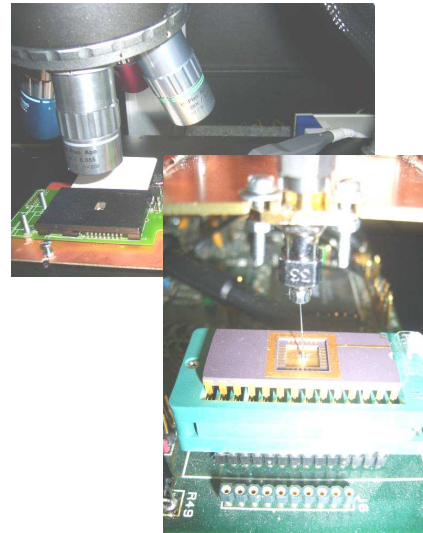
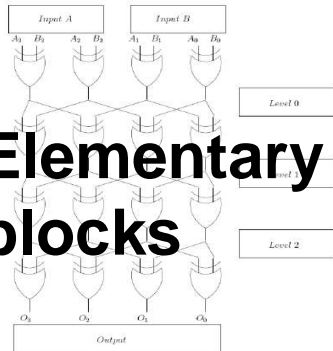
AES with fault and SCA counter-measures



Security of ASIC crypto

CALISSON

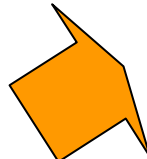
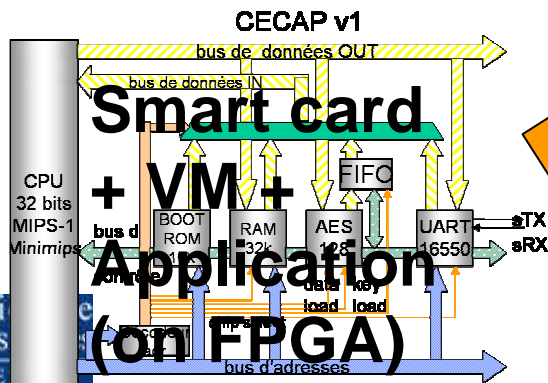
Elementary blocks



Knowledge on syndroms

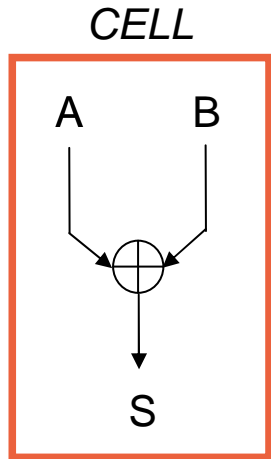
SOS

Smart card Application (on FPGA)

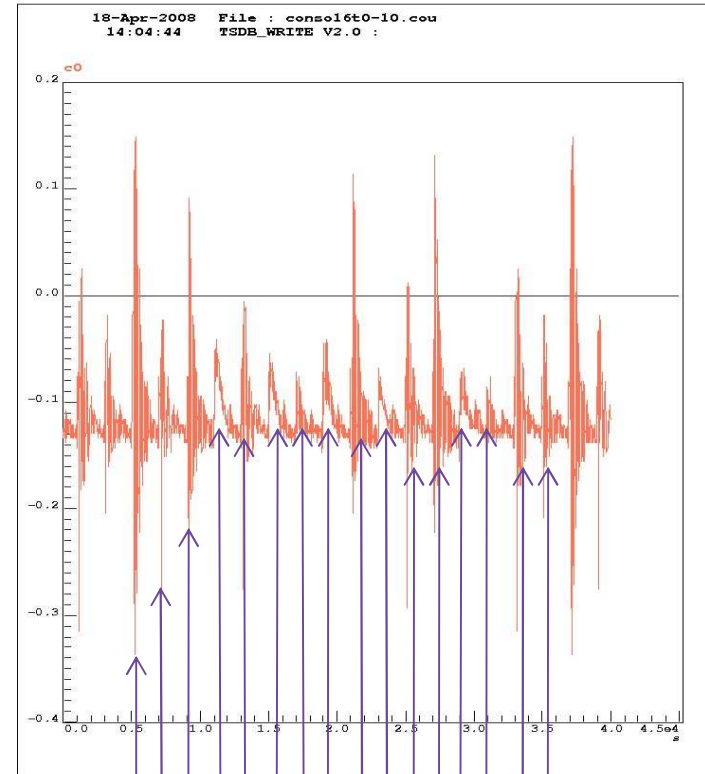
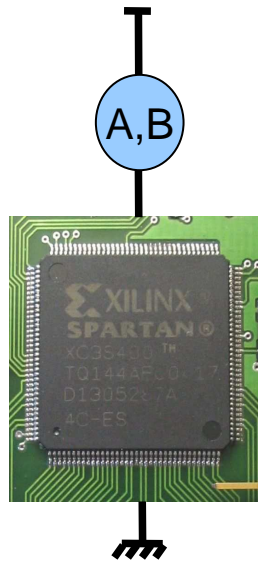


Security of FPGA based systems

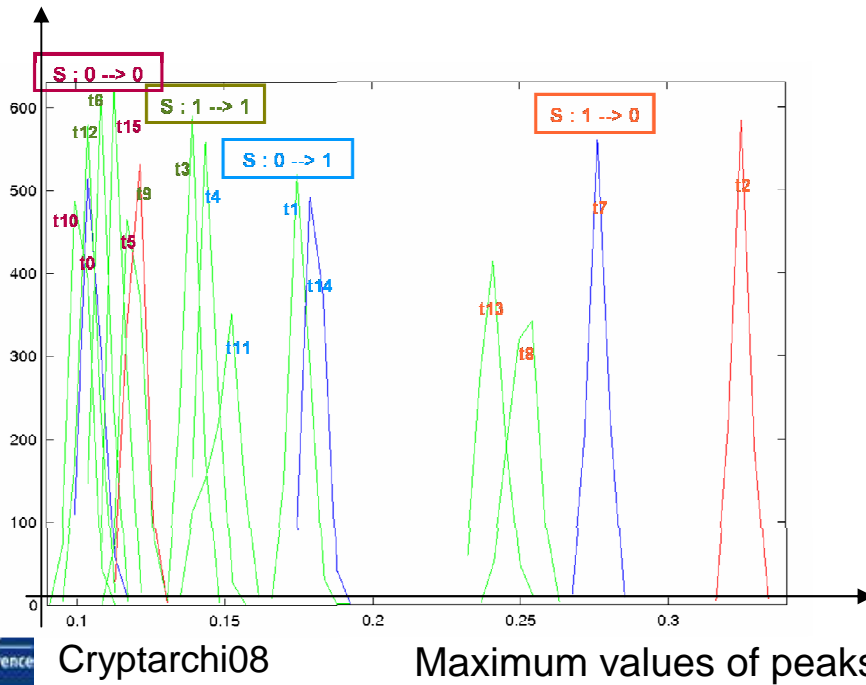
Education: lab "template on FPGA"



x 64

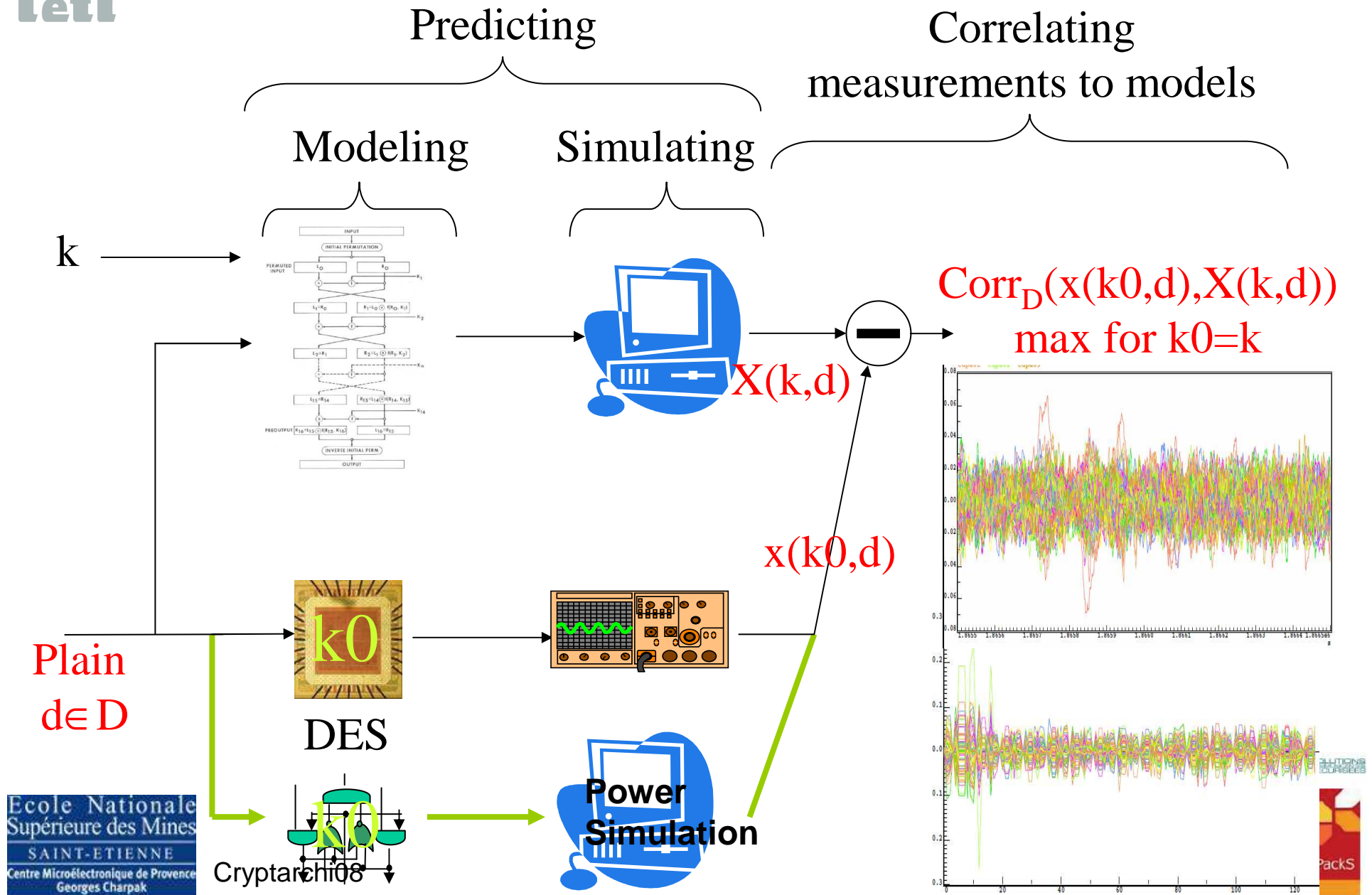


Number of realizations



16 transitions = 16 profiles

Education: lab “Differential Power Analysis”



Enhancements

- Shortcoming equipments
 - Addition of IR camera to laser bench
 - More EM probes
 - Contactless bench
- Future equipments
 - Advanced Laser bench
 - More preparation tools